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Kind regards,

Team Nexperia



# PDTD113/123/143/114EQA **Series** 50 V, 500 mA NPN resistor-equipped transistors

Rev. 1 — 4 February 2016

**Product data sheet** 

#### **Product profile** 1.

#### 1.1 General description

NPN Resistor-Equipped Transistor (RET) family in a leadless ultra small DFN1010D-3 (SOT1215) Surface-Mounted Device (SMD) plastic package with visible and solderable side pads.

#### **Product overview** Table 1.

Type number	R1	R2	Package NXP	PNP complement
PDTD113EQA	1 kΩ	1 kΩ	DFN1010D-3	PDTB113EQA
PDTD123EQA	2.2 kΩ	2.2 kΩ	(SOT1215)	PDTB123EQA
PDTD143EQA	4.7 kΩ	4.7 kΩ		PDTB143EQA
PDTD114EQA	10 kΩ	10 kΩ		PDTB114EQA

#### 1.2 Features and benefits

- 500 mA output current capability
- Built-in bias resistors
- ± 10% resistor ratio tolerance
- Simplifies circuit design
- Reduces component count

#### 1.3 Applications

- Digital applications
- Cost saving alternative for BC807/BC817 series in digital applications

#### 1.4 Quick reference data

#### Table 2. **Quick reference data**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base	-	-	50	V
I <sub>O</sub>	output current		-	-	500	mA



- Reduced pick and place costs
- Low package height of 0.37 mm
- Suitable for Automatic Optical Inspection (AOI) of solder joint
- AEC-Q101 qualified
- Controlling IC inputs
- Switching loads

50 V, 500 mA NPN resistor-equipped transistors

### 2. Pinning information

Table 3.	Pinning			
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	I	input (base)		
2	GND	GND (emitter)		
3	0	output (collector)		
4	0	output (collector)	4 3 2 Transparent top view	GND

### 3. Ordering information

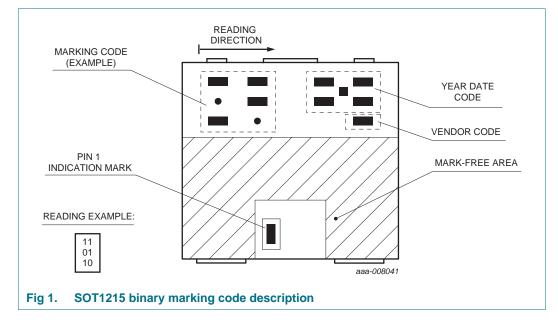
Gable 4. Ordering information							
Type number Package							
	Name	Description	Version				
PDTD113EQA	DFN1010D-3	plastic thermal enhanced ultra thin small outline	SOT1215				
PDTD123EQA		package; no leads; 3 terminals; body: $1.1 \times 1.0 \times 0.37$ mm					
PDTD143EQA							
PDTD114EQA							

50 V, 500 mA NPN resistor-equipped transistors

#### 4. Marking

Table 5. Marking codes	
Type number	Marking code
PDTD113EQA	01 00 11
PDTD123EQA	01 01 10
PDTD143EQA	01 10 01
PDTD114EQA	01 11 01

#### 4.1 Binary marking code description



### 5. Limiting values

#### Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CBO</sub>	collector-base voltage	open emitter	-	50	V
V <sub>CEO</sub>	collector-emitter voltage	open base	-	50	V
V <sub>EBO</sub>	emitter-base voltage	open collector	-	10	V

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Table 6.	Limiting	values	continued
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In accordance with the Absolute Maximum Rating System (IEC 60134).

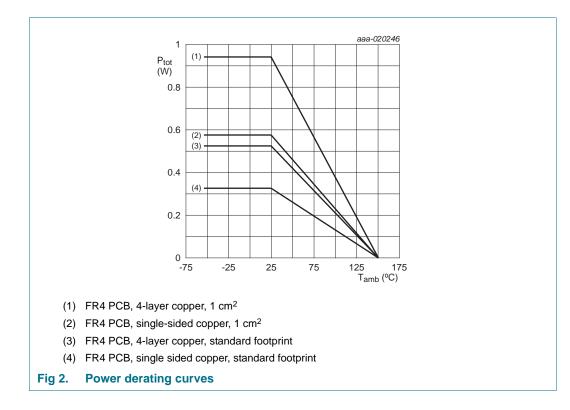
Symbol	Parameter	Parameter Conditions		Max	Unit				
VI	input voltage								
	PDTD113EQA		-10	+10	V				
	PDTD123EQA		-10	+12	V				
	PDTD143EQA		-10	+30	V				
	PDTD114EQA		-10	+50	V				
I <sub>O</sub>	output current		-	500	mA				
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1]</u> -	325	mW				
			[2] -	575	mW				
			<u>[3]</u> _	525	mW				
			<u>[4]</u> _	940	mW				
Tj	junction temperature		-	150	°C				
T <sub>amb</sub>	ambient temperature		-55	+150	°C				
T <sub>stg</sub>	storage temperature		-65	+150	°C				

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.

[3] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



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#### 6. Thermal characteristics

Table 7.	Thermal	characteristics
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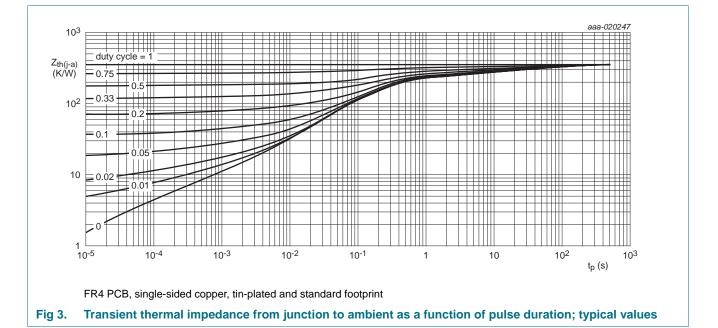
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction	in free air	[1]	-	-	385	K/W
	to ambient	[2]	-	-	218	K/W	
			[3]	-	-	239	K/W
			[4]	-	-	133	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point			-	-	40	K/W

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.

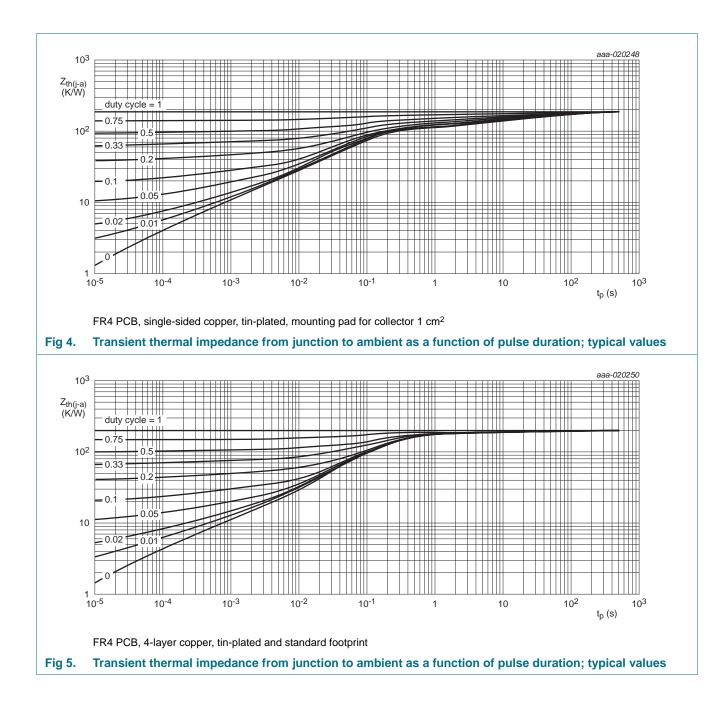
[3] Device mounted on an FR4 PCB, 4-layer copper, tin-plated and standard footprint.

[4] Device mounted on an FR4 PCB, 4-layer copper, tin-plated; mounting pad for collector 1 cm<sup>2</sup>.



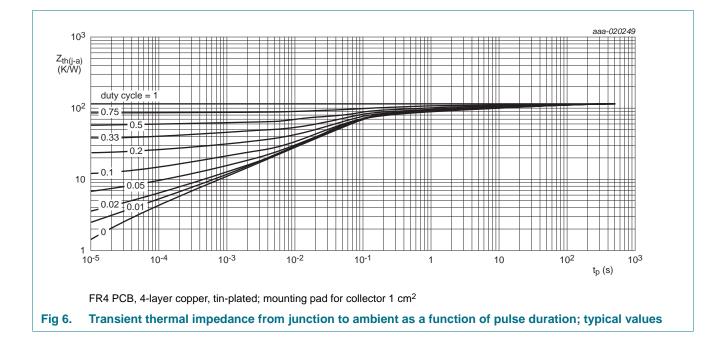
### PDTD113/123/143/114EQA

50 V, 500 mA NPN resistor-equipped transistors



# PDTD113/123/143/114EQA

50 V, 500 mA NPN resistor-equipped transistors



50 V, 500 mA NPN resistor-equipped transistors

### 7. Characteristics

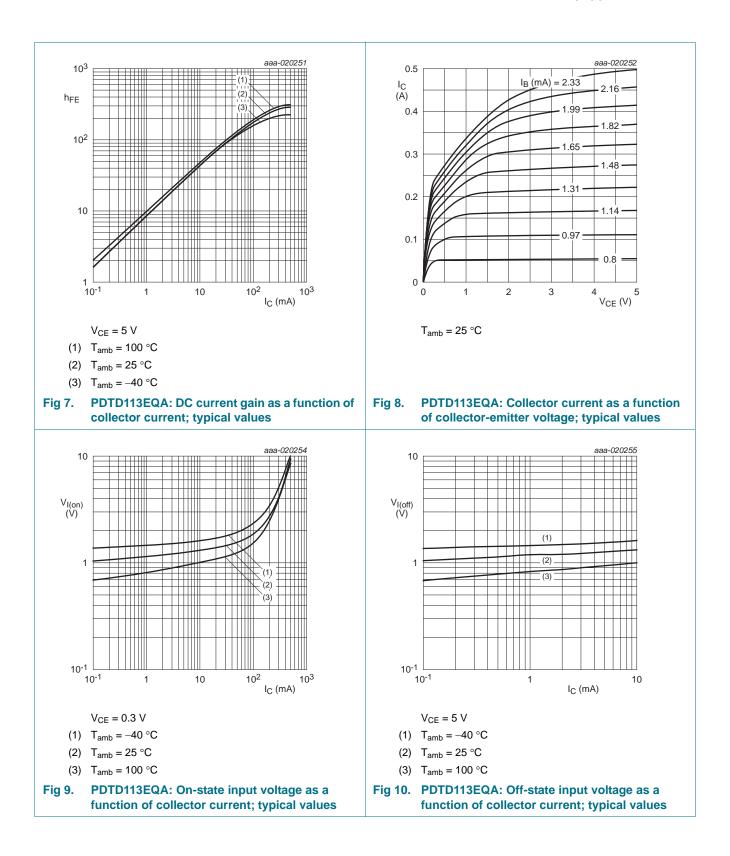
Symbol	Parameter	Conditions	Min	Тур	Max	Unit		
СВО	collector-base cut-off current	$V_{CB} = 50 \text{ V}; \text{ I}_{E} = 0 \text{ A}$	-	-	100	nA		
CEO	collector-emitter cut-off current	$V_{CE} = 50 \text{ V}; \text{ I}_{B} = 0 \text{ A}$	-	-	0.5	μA		
EBO	emitter-base cut-off current							
	PDTD113EQA	$V_{EB} = 5 \text{ V}; \text{ I}_{C} = 0 \text{ A}$	-	-	4	mA		
	PDTD123EQA		-	-	2	mA		
	PDTD143EQA		-	-	0.9	mA		
	PDTD114EQA				0.4	mA		
JFE	DC current gain							
	PDTD113EQA	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 50 \text{ mA}$	33	-	-			
	PDTD123EQA	-	40	-	-			
	PDTD143EQA	-	60	-	-			
	PDTD114EQA	-	70	-	-			
√ <sub>CEsat</sub>	collector-emitter saturation voltage	$I_{\rm C}$ = 50 mA; $I_{\rm B}$ = 2.5 mA	-	-	100	mV		
√ <sub>I(off)</sub>	off-state input voltage							
	PDTD113EQA	$V_{CE} = 5 \text{ V}; \text{ I}_{C} = 100 \mu\text{A}$	0.6	1.05	1.5	V		
	PDTD123EQA		0.6	1.05	1.8	V		
	PDTD143EQA	-	0.6	1.05	1.5	V		
	PDTD114EQA	-	0.6	1.05	1.5	V		
V <sub>I(on)</sub>	on-state input voltage			·	Ċ			
	PDTD113EQA	$V_{CE} = 0.3 \text{ V}; I_{C} = 20 \text{ mA}$	1	1.45	1.8	V		
	PDTD123EQA		1	1.5	2	V		
	PDTD143EQA		1	1.7	2.2	V		
	PDTD114EQA	-	1	2.2	3	V		
٦1	bias resistor 1 (input)	<u>[1</u>	L					
	PDTD113EQA		0.7	1	1.3	kΩ		
	PDTD123EQA		1.54	2.2	2.86	kΩ		
	PDTD143EQA		3.3	4.7	6.1	kΩ		
	PDTD114EQA		7	10	13	kΩ		
R2/R1	bias resistor ratio	[1	0.9	1	1.1			
Cc	collector capacitance	V <sub>CB</sub> = 10 V; I <sub>E</sub> = i <sub>e</sub> = 0 A; f = 1 MHz	-	5	-	pF		
fT	transition frequency	$V_{CE} = 5 \text{ V}; I_C = 50 \text{ mA}; f = 100 \text{ MHz}$	<u> </u>	210	-	MHz		

[1] See section test information for resistor calculation and test conditions.

[2] Characteristics of built-in transistor.

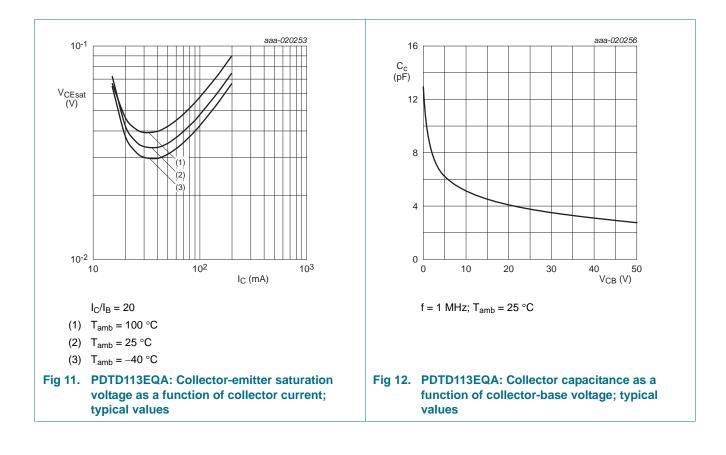
PDTD113\_123\_143\_114EQA\_SER Product data sheet

50 V, 500 mA NPN resistor-equipped transistors



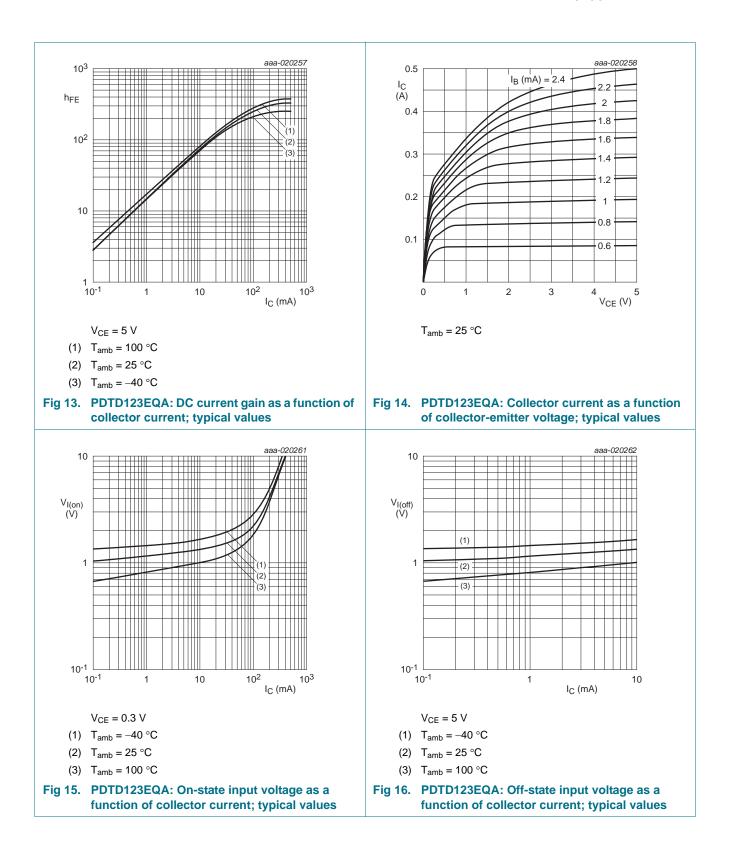
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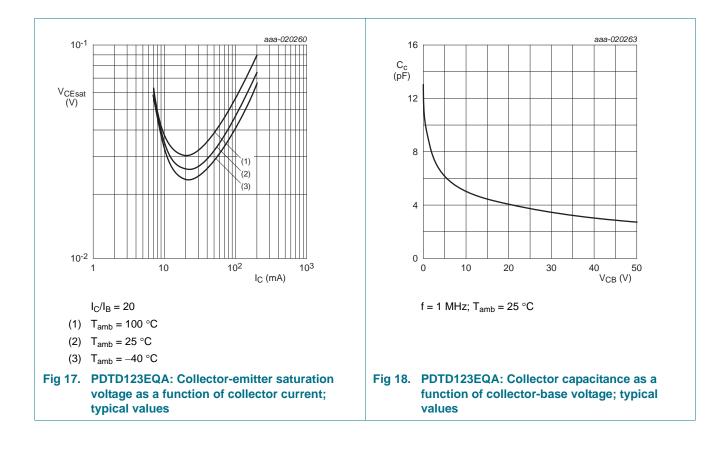
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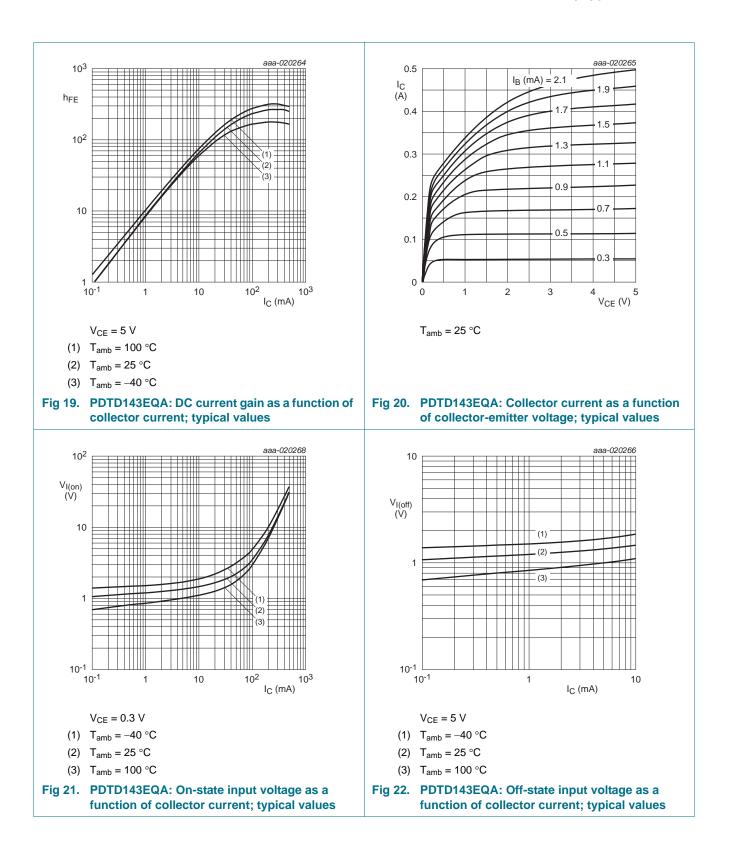


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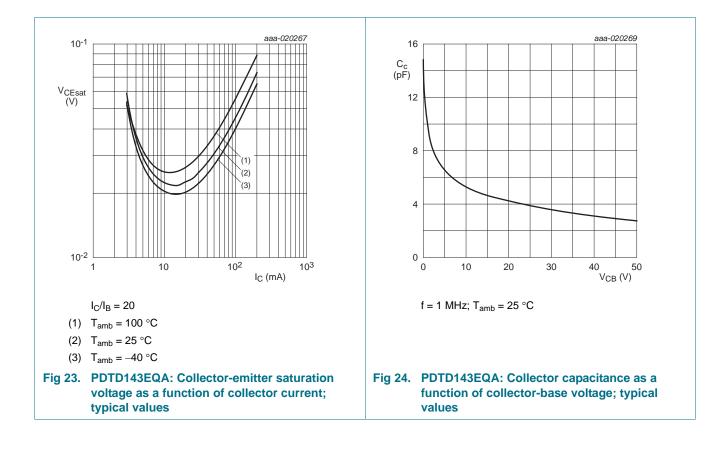


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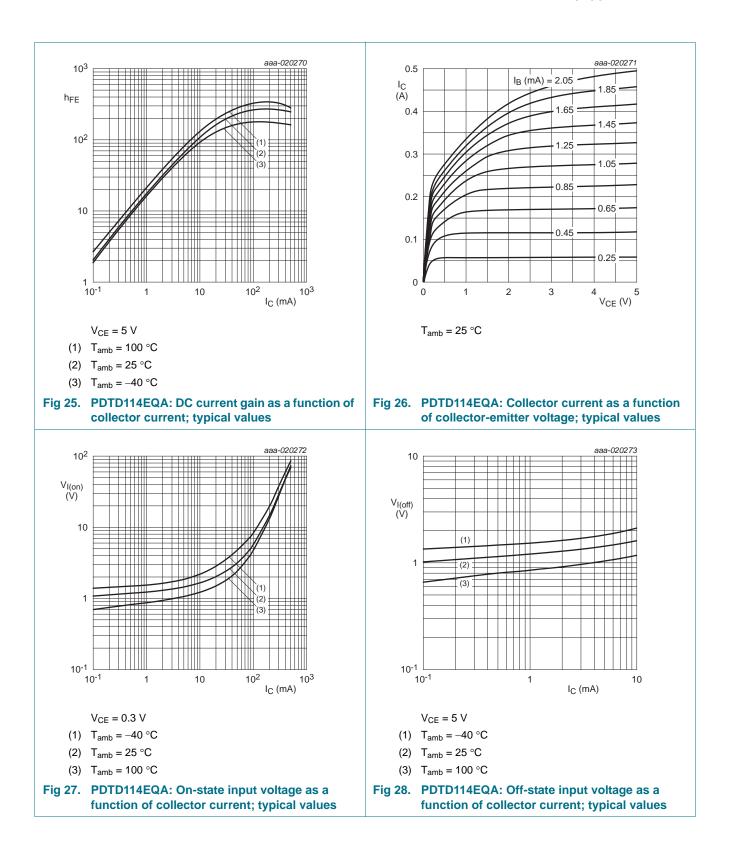


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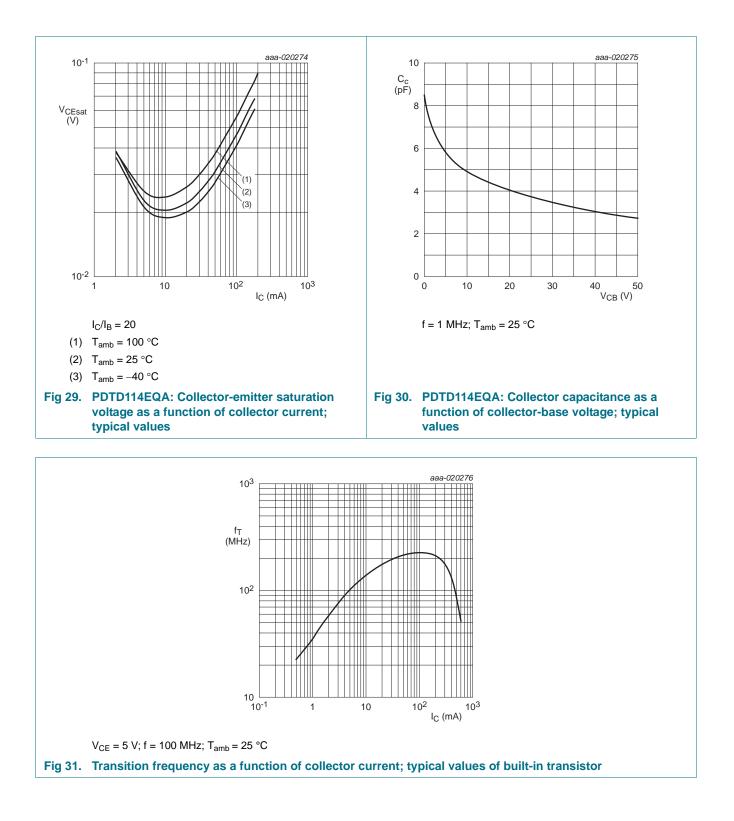


50 V, 500 mA NPN resistor-equipped transistors



# PDTD113/123/143/114EQA

50 V, 500 mA NPN resistor-equipped transistors



50 V, 500 mA NPN resistor-equipped transistors

#### 8. Test information

#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

#### 8.2 Resistor calculation

• Calculation of bias resistor 1 (R1):

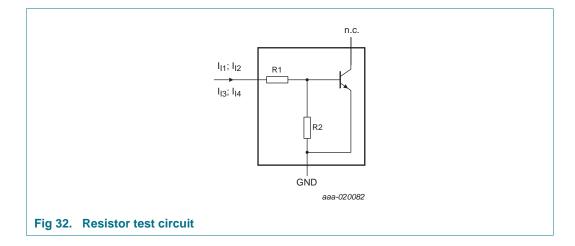
$$R1 = \frac{V(I_{12}) - V(I_{11})}{I_{12} - I_{11}}$$

• Calculation method A of bias resistor ratio (R2/R1):

$$\frac{R2}{R1} = \frac{V(I_{13})}{R1 \cdot I_{13}} - 1$$

• Calculation method B of bias resistor ratio (R2/R1):

$$\frac{R2}{R1} = \frac{V(I_{14}) - V(I_{13})}{R1 \cdot (I_{14} - I_{13})} - 1$$



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#### 8.3 Resistor test conditions

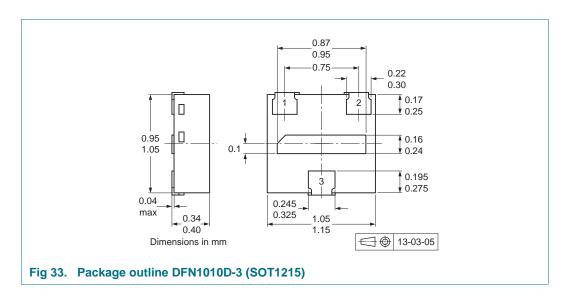
#### Table 9. Resistor test conditions

Type number		R1	R2	Test conditions			
		kΩ kΩ l <sub>l1</sub>		I <sub>12</sub>	I <sub>13</sub>	I <sub>14</sub>	
PDTD113EQA	<u>[1]</u>	1	1	1.5 mA	1.9 mA	–2.2 mA	-
PDTD123EQA	<u>[1]</u>	2.2	2.2	0.7 mA	0.8 mA	–0.75 mA	-
PDTD143EQA	[2]	4.7	4.7	1.3 mA	1.5 mA	–1.05 mA	–1.25 mA
PDTD114EQA	[2]	10	10	0.7 mA	0.8 mA	–0.45 mA	–0.55 mA

[1] Uses calculation method A of bias resistor ratio R2/R1

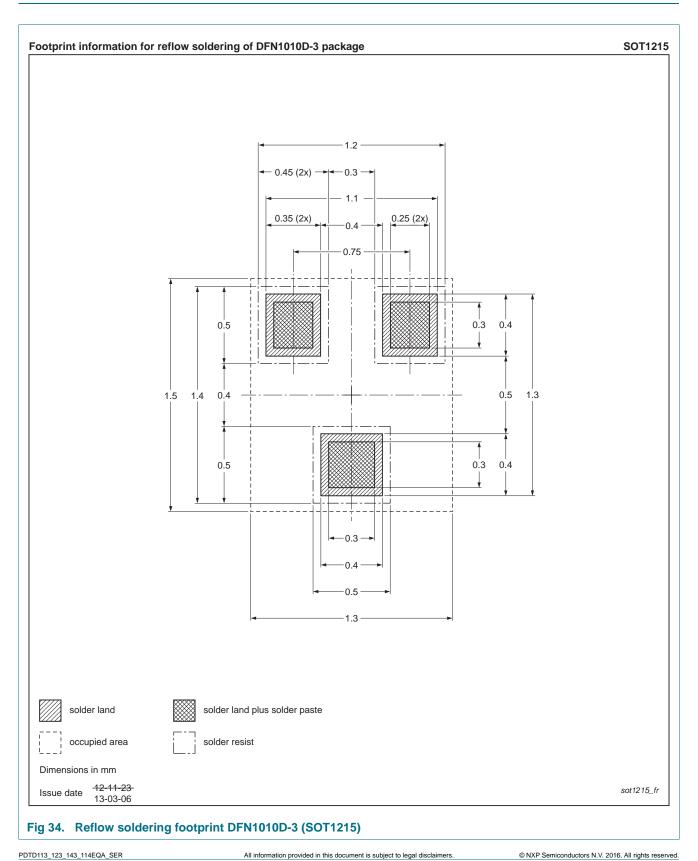
[2] Uses calculation method B of bias resistor ratio R2/R1

### 9. Package outline



50 V, 500 mA NPN resistor-equipped transistors

### **10. Soldering**



Product data sheet

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### 11. Revision history

#### Table 10. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PDTD113_123_143_114EQA_SER	20160104	Product data sheet	-	-
v.1				

50 V, 500 mA NPN resistor-equipped transistors

### 12. Legal information

#### 12.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions"

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